

Product Change Notification: CAAN-02LKNV587

Date:

05-Sep-2024

Product Category:

Digital Temperature Sensors

Notification Subject:

CCB 7149 Final Notice: Qualification of MTAI as a new assembly site for EMC1402-3-ACZL-TR, EMC1402-4-ACZL-TR, EMC1412-1-ACZL-TR, EMC1412-2-ACZL-TR, EMC1412-A-ACZL-TR and EMC1422-2-ACZL-TR catalog part numbers (CPN) available in 8L MSOP (3x3mm) package with Matte Tin lead finish.

Affected CPNs:

CAAN-02LKNV587_Affected_CPN_09052024.pdf CAAN-02LKNV587 Affected CPN 09052024.csv

Notification Text:

PCN Status:Final Notification

PCN Type:Manufacturing Change

Microchip Parts Affected: Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:Qualification of MTAI as a new assembly site for EMC1402-3-ACZL-TR, EMC1402-4-ACZL-TR, EMC1412-1-ACZL-TR, EMC1412-2-ACZL-TR, EMC1412-A-ACZL-TR and EMC1422-2-ACZL-TR catalog part numbers (CPN) available in 8L MSOP (3x3mm) package with Matte Tin lead finish.

Pre and Post Change Summary:

	Pre Change	Post Change		
Assembly Site	HANA Microelectronics-Chi	Microchip Technology Thailand (HQ)		

	na (HANC)	(MTAI)	
Wire Material	Au	Au	
Die Attach Material	2200D	8390A	
Molding Compound Material	KMC-3580P8	G600V	
Lead-Frame Material	A194	CDA194*	
Lead-Frame Paddle Size	71 x 92 mils	68 x 94 mils	
Lead finish	NiPdAu	Matte tin	
Moisture Sensitivity Level (MSL)	MSL 2	MSL 1	
DAP Surface Prep	DAP Surface Prep Ag plated		

Note: *C194, A194 or CDA194 Lead frame material are the same, it is just a MCHP internal labelling difference.

Impacts to Data Sheet:None

Change ImpactNone

Reason for Change:To improve on-time delivery performance by qualifying MTAI as additional assembly site.

Change Implementation Status:In Progress

Estimated First Ship Date:October 14, 2024 (date code: 2442)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	September 2024			October 2024					
Workweek	36	37	38	39	40	41	42	43	44
Qual Report Availability	х								
Final PCN Issue Date	Х								
Estimated Implementation Date							X		

Method to Identify Change:Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History:September 05, 2024: Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_CAAN-02LKNV587 Qual Report.pdf

Please contact your local **Microchip sales office** with questions or concerns regarding this notification.

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the **PCN home page** select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)

EMC1402-3-ACZL-TR

EMC1402-4-ACZL-TR

EMC1412-1-ACZL-TR

EMC1412-2-ACZL-TR

EMC1412-A-ACZL-TR

EMC1422-2-ACZL-TR



QUALIFICATION REPORT SUMMARY RELIABILITY LABORATORY

PCN#: CAAN-02LKNV587

Date: February 02, 2014

Qualification of MTAI as a new assembly site for EMC1402-3-ACZL-TR, EMC1402-4-ACZL-TR, EMC1412-1-ACZL-TR, EMC1412-2-ACZL-TR, EMC1412-A-ACZL-TR and EMC1422-2-ACZL-TR catalog part numbers (CPN) available in 8L MSOP (3x3mm) package with Matte Tin lead finish will qualify by similarity.



Purpose Qualification of MTAI as a new assembly site for EMC1402-3-ACZL-TR,

EMC1402-4-ACZL-TR, EMC1412-1-ACZL-TR, EMC1412-2-ACZL-TR, EMC1412-A-ACZL-TR and EMC1422-2-ACZL-TR catalog part numbers (CPN) available in 8L MSOP (3x3mm) package with Matte Tin lead finish

will qualify by similarity.

CCB No. 1218 and 7149

PRODUCT INFORMATION

PACKAGE TYPE 3X3mm

LEAD COUNT 8

WAFER DIAMETER 8 inches WAFER THICKNESS 8mils

Material used in the Assembly:

LEAD FRAME MATERIAL Cu – C194 (STAMP) LEADFRAME PLATING Ag Single Ring + BOT

DIE ATTACH EPOXY TYPE 8390A WIRE TYPE Au MOLDING COMPOUND TYPE G600V LEAD FINISHING COMPOSITION Matte - Sn



Manufacturing Information

Assembly Lot No. Wafer Lot No.

MTAI142203501.000 GF02913353153.100 MTAI142401871.000 GF35913353234.300 MTAI142402026.000 GF35913353234.300

Assembly Yield Report

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In	Out	Yield
700	700	100.00%
700	700	100.00%
700	700	100.00%
	700	700 700 700 700

SUMMARY RESULT OF RELIABILITY TEST MSL LEVEL 1

Performed RE studies on 3 qual lots 1/ Lot MTAI142401871.000 2/ Lot MTAI142402026.000 3/ Lot MTAI142203501.000

TEST ITEM	TEST CONDITION	TEST INTERVAL	VISUAL INSPECTION	O/S & ATE TEST	RESULT
PRECONDITION TEST	JEDEC 22-A113 Level 1 85C/85%RH 3 X IR-/ 260C +5, - 0	168 HRS	LOT1: 0/240 LOT2: 0/240 LOT3: 0/240	LOT1: 0/240 LOT2: 0/240 LOT3: 0/240	PASSED
TEMPERATURE CYCLE TEST	JEDEC 22-A104 -65'C~150'C	1000 Cycles	LOT1: 0/60 LOT2: 0/60 LOT3: 0/60	LOT1: 0/60 LOT2: 0/60 LOT3: 0/60	PASSED
HIGH TEMPERATURE STORAGE TEST	JEDEC 22-A103 150°C	1000 hours	LOT1: 0/60 LOT2: 0/60 LOT3: 0/60	LOT1: 0/60 LOT2: 0/60 LOT3: 0/60	PASSED
HAST TEST (NO BIAS)	JEDEC 22-A118 130'C/85%RH 33.5PSIA	100 Hrs	LOT1: 0/60 LOT2: 0/60 LOT3: 0/60	LOT1: 0/60 LOT2: 0/60 LOT3: 0/60	PASSED
TEMPERATURE HUMIDITY TEST (NO BIAS)	JEDEC 22-A101 85'C/85%RH	1008 hours	LOT1: 0/60 LOT2: 0/60 LOT3: 0/60	LOT1: 0/60 LOT2: 0/60 LOT3: 0/60	PASSED